

RJK5014DPK

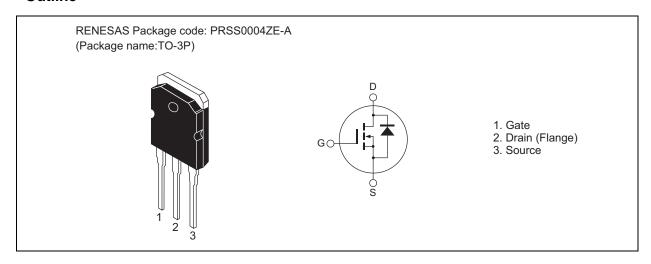
Silicon N Channel MOS FET High Speed Power Switching

REJ03G1458-0100 Rev.1.00 Jun 06, 2006

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



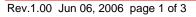
Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	500	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	19	Α
Drain peak current	I _{D (pulse)} Note1	38	А
Body-drain diode reverse drain current	I _{DR}	19	А
Body-drain diode reverse drain peak current	I _{DR (pulse)} Note1	38	Α
Avalanche current	I _{AP} Note3	5	Α
Avalanche energy	E _{AR} Note3	1.3	mJ
Channel dissipation	Pch Note2	150	W
Channel to case thermal impedance	θch-c	0.833	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \mu s$, duty cycle $\le 1\%$

- 2. Value at Tc = 25°C
- 3. STch = 25° C, Tch $\leq 150^{\circ}$ C





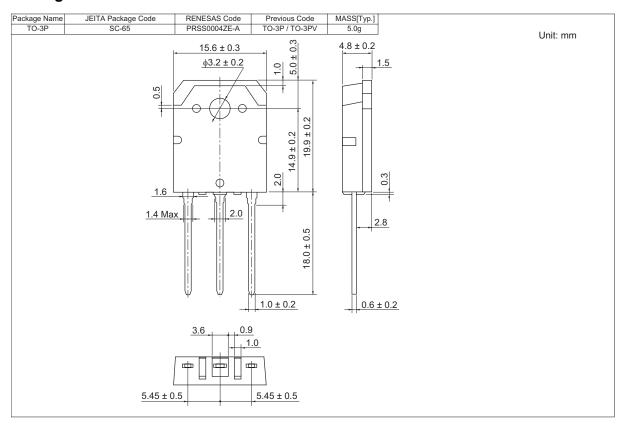
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	500	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 500 \text{ V}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	3.0	_	4.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS(on)}	_	0.315	0.380	Ω	$I_D = 9.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	1800	_	pF	V _{DS} = 25 V
Output capacitance	Coss	_	190	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	24	_	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	_	36	_	ns	I _D = 9.5 A
Rise time	t _r	_	41	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}	_	93	_	ns	$R_L = 26.3 \Omega$
Fall time	t _f	_	39	_	ns	$Rg = 10 \Omega$
Total gate charge	Qg	_	46	_	nC	V _{DD} = 400 V
Gate to source charge	Qgs	_	9	_	nC	V _{GS} = 10 V
Gate to drain charge	Qgd	_	20	_	nC	I _D = 19 A
Body-drain diode forward voltage	V_{DF}	_	0.91	1.55	V	$I_F = 19 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-drain diode reverse recovery time	t _{rr}	_	320	_	ns	$I_F = 19 \text{ A}, V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse test

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
RJK5014DPK-00	360 pcs	Box (Tube)

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